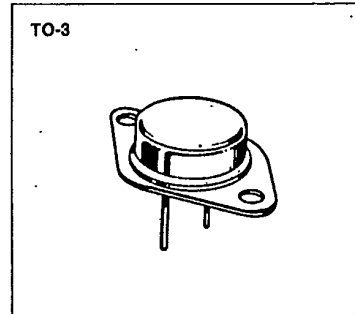


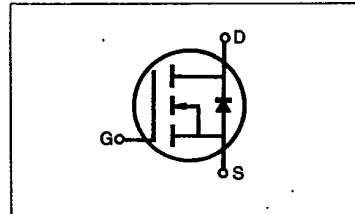
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IRF150/151/152/153**N-CHANNEL
POWER MOSFETS****FEATURES**

- Low $R_{DS(on)}$
- Improved inductive ruggedness
- Fast switching times
- Rugged polysilicon gate cell structure
- Low input capacitance
- Extended safe operating area
- Improved high temperature reliability
- TO-3 package (High current)

**PRODUCT SUMMARY**

Part Number	V_{DS}	$R_{DS(on)}$	I_D
IRF150	100V	0.055 Ω	40A
IRF151	60V	0.055 Ω	40A
IRF152	100V	0.08 Ω	33A
IRF153	60V	0.08 Ω	33A

**MAXIMUM RATINGS**

Characteristic	Symbol	IRF150	IRF151	IRF152	IRF153	Unit
Drain-Source Voltage (1)	V_{DSS}	100	60	100	60	Vdc
Drain-Gate Voltage ($R_{GS}=1.0M\Omega$) (1)	V_{DGR}	100	60	100	60	Vdc
Gate-Source Voltage	V_{GS}	± 20				Vdc
Continuous Drain Current $T_C=25^\circ C$	I_D	40	40	33	33	Adc
Continuous Drain Current $T_C=100^\circ C$	I_D	25	25	20	20	Adc
Drain Current—Pulsed (3)	I_{DM}	160	160	132	132	Adc
Gate Current—Pulsed	I_{GM}	± 1.5				Adc
Total Power Dissipation @ $T_C=25^\circ C$ Derate above $25^\circ C$	P_D	150 1.2				Watts W/ $^\circ C$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-55 to 150				$^\circ C$
Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5 seconds	T_L	300				$^\circ C$

Notes: (1) $T_J=25^\circ C$ to $150^\circ C$ (2) Pulse test: Pulse width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

(3) Repetitive rating: Pulse width limited by max. junction temperature

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IRF150/151/152/153

N-CHANNEL
POWER MOSFETSELECTRICAL CHARACTERISTICS (T_C=25°C unless otherwise specified)

Characteristic	Symbol	Type	Min	Typ	Max	Units	Test Conditions
Drain-Source Breakdown Voltage	BV _{DSS}	IRF150 IRF152	100	—	—	V	V _{GS} =0V
		IRF151 IRF153	60	—	—	V	I _D =250μA
Gate Threshold Voltage	V _{GS(th)}	ALL	2.0	—	4.0	V	V _{DS} =V _{GS} , I _D =250μA
Gate-Source Leakage Forward	I _{GSS}	ALL	—	—	100	nA	V _{GS} =20V
Gate-Source Leakage Reverse	I _{GSS}	ALL	—	—	-100	nA	V _{GS} =-20V
Zero Gate Voltage Drain Current	I _{DSS}	ALL	—	—	250	μA	V _{DS} =Max. Rating, V _{GS} =0V
			—	—	1000	μA	V _{DS} =Max. Rating×0.8, V _{GS} =0V, T _C =125°C
On-State Drain-Source Current (2)	I _{D(on)}	IRF150 IRF151	40	—	—	A	V _{DS} >I _{D(on)} ×R _{DS(on)} max., V _{GS} =10V
		IRF152 IRF153	33	—	—	A	
Static Drain-Source On-State Resistance (2)	R _{DS(on)}	IRF150 IRF151	—	0.04	0.055	Ω	V _{GS} =10V, I _D =20A
		IRF152 IRF153	—	0.06	0.08	Ω	
Forward Transconductance (2)	g _{fs}	ALL	9.0	12.3	—	Ω	V _{DS} >I _{D(on)} ×R _{DS(on)} max., I _D =20A
Input Capacitance	C _{iss}	ALL	—	2900	3000	pF	
Output Capacitance	C _{oss}	ALL	—	1050	1500	pF	V _{GS} =0V, V _{DS} =25V, f=1.0MHz
Reverse Transfer Capacitance	C _{rss}	ALL	—	450	500	pF	
Turn-On Delay Time	t _{d(on)}	ALL	—	—	35	ns	V _{DD} =0.5BV _{DSS} , I _D =20A, Z _O =4.7Ω (MOSFET switching times are essentially independent of operating temperature.)
Rise Time	t _r	ALL	—	—	100	ns	
Turn-Off Delay Time	t _{d(off)}	ALL	—	—	125	ns	
Fall Time	t _f	ALL	—	—	100	ns	
Total Gate Charge (Gate-Source Plus Gate-Drain)	Q _g	ALL	—	72	120	nC	V _{GS} =10V, I _D =50A, V _{DS} =0.8 Max. Rating (Gate charge is essentially independent of operating temperature.)
Gate-Source Charge	Q _{gs}	ALL	—	18	—	nC	
Gate-Drain ("Miller") Charge	Q _{gd}	ALL	—	54	—	nC	

THERMAL RESISTANCE

Junction-to-Case	R _{thJC}	ALL	—	—	0.83	K/W	
Case-to-Sink	R _{thCS}	ALL	—	0.1	—	K/W	Mounting surface flat, smooth, and greased
Junction-to-Ambient	R _{thJA}	ALL	—	—	30	K/W	Free Air Operation

Notes: (1) T_J=25°C to 150°C

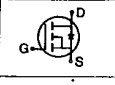
(2) Pulse test: Pulse width≤300μs, Duty Cycle≤2%

(3) Repetitive rating: Pulse width limited by max. junction temperature

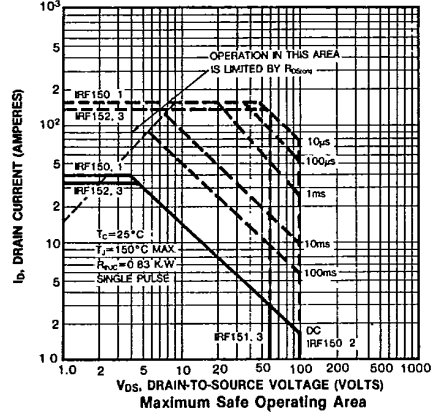
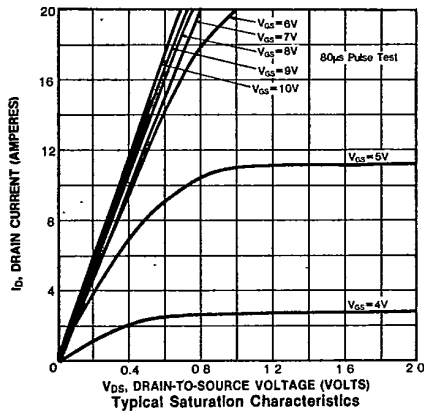
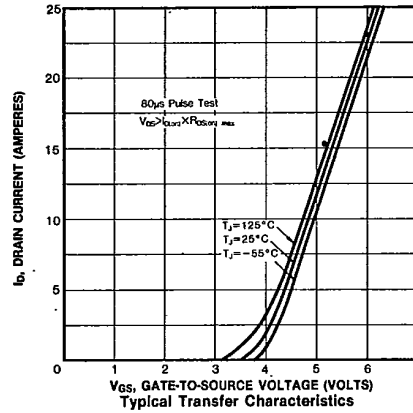
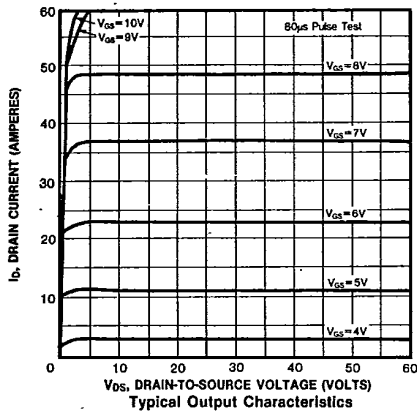
**N-CHANNEL
POWER MOSFETS**

IRF150/151/152/153

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

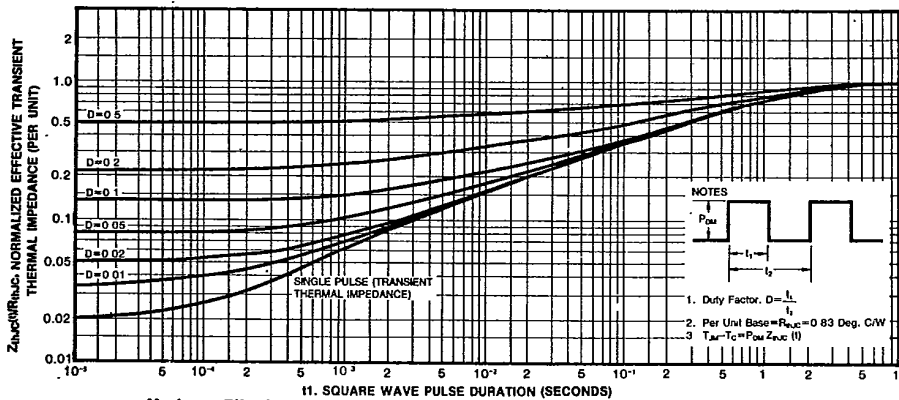
Characteristic	Symbol	Type	Min	Typ	Max	Units	Test Conditions
Continuous Source Current (Body Diode)	I _S	IRF150 IRF151	—	—	40	A	Modified MOSFET symbol showing the integral reverse P-N junction rectifier 
		IRF152 IRF153	—	—	33	A	
Pulse Source Current (Body Diode) (3)	I _{SM}	IRF150 IRF151	—	—	160	A	
		IRF152 IRF153	—	—	132	A	
Diode Forward Voltage (2)	V _{SD}	IRF150 IRF151	—	—	2.5	V	T _C =25°C, I _S =40A, V _{GS} =0V
		IRF152 IRF153	—	—	2.3	V	T _C =25°C, I _S =33A, V _{GS} =0V
Reverse Recovery Time	t _{rr}	ALL	—	600	—	ns	T _J =150°C, I _F =40A, dI _F /dt=100A/μs

Notes: (1) T_J=25°C to 150°C (2) Pulse test: Pulse width ≤ 300μs, Duty Cycle ≤ 2%
(3) Repetitive rating: Pulse width limited by max. junction temperature

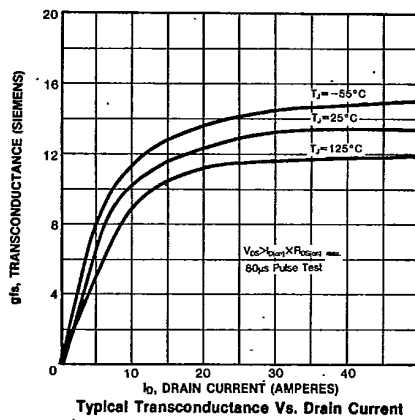


IRF150/151/152/153

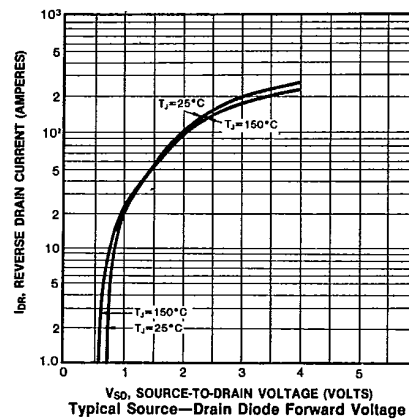
N-CHANNEL
POWER MOSFETS



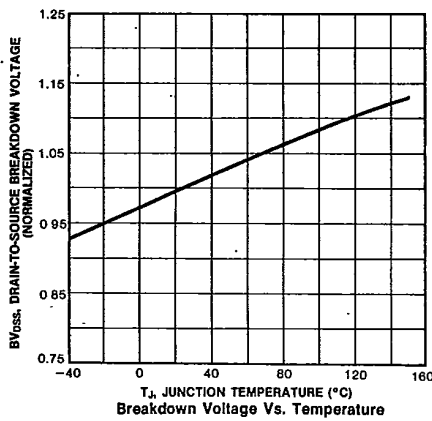
11. SQUARE WAVE PULSE DURATION (SECONDS)
Maximum Effective Transient Thermal Impedance Junction-to-Case Vs. Pulse Duration



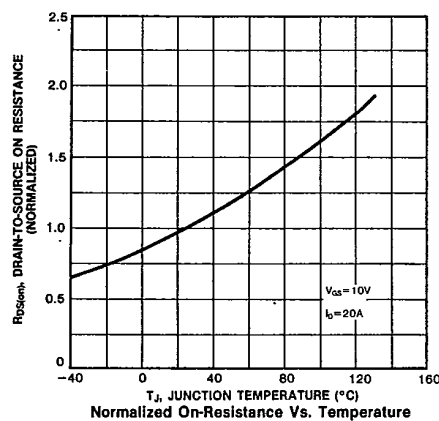
Typical Transconductance Vs. Drain Current



Typical Source-Drain Diode Forward Voltage



Breakdown Voltage Vs. Temperature



Normalized On-Resistance Vs. Temperature

IRF150/151/152/153

N-CHANNEL POWER MOSFETS

